PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Martin Cenac	01/26/2011

RECEIVING PARTY DATA

Name:	BLOWOUT TOOLS INC.
Street Address:	2202 Oil Center Court
City:	Houston
State/Country:	TEXAS
Postal Code:	77073

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12276863

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	A07317US (71768.52)
NAME OF SUBMITTER:	Gregory C. Smith

Total Attachments: 2

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\$40.00

PATENT REEL: 025705 FRAME: 0803

ASSIGNMENT

WHEREAS I, Martin Cenac, am a joint inventor of an invention entitled "A Method of Direct Hot Tapping Into A Multiple Production String Without Removing Outer Layers of Casing", an application for United States Letters Patent for which having been filed on 24 November 2008 as Serial No. 12/276,863; and

WHEREAS, BLOWOUT TOOLS, INC. (ASSIGNEE), a Texas corporation, is desirous of acquiring the entire right, title and interest in and to the aforesaid invention throughout the world, and all right, title and interest in, to and under any and all Letters Patent of the United States and all other countries throughout the world;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) to us in hand paid by ASSIGNEE and for other good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell, assign, transfer and set over to ASSIGNEE, all right, title and interest in and to the said invention and any improvements thereto throughout the world, and said application for U.S. Letters Patent and said International Patent Application, and any and all divisions, continuations, continuations-in-part, and reissues thereof, and any and all Letters Patent of the United States and foreign countries which may be granted therefor, the same to beheld and enjoyed by ASSIGNEE for its own use and benefit, and for the use and benefit of its successors, assigns, or other legal representatives, to the end of the term or terms for which said Letters Patent of the United States or foreign countries are or may be granted or reissued, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all Letters Patent of the United States on said invention or resulting from said application and from any and all divisions, continuations, continuations-in-part, and reissues thereof, to ASSIGNEE, as assignee of our entire interest, and hereby covenant that I have the full right to convey the entire interest herein assigned, and that I have not executed and will not execute any agreement in conflict herewith.

And I further hereby covenant and agree that I will, at any time, upon request, execute and deliver any and all papers that may be necessary or desirable to perfect the title of said invention

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and to such Letters Patent as may be granted therefor, to ASSIGNEE, its successors, assigns, or other legal representatives and that if ASSIGNEE, its successors, assigns or other legal representatives shall desire to file any divisional, continuation, or continuation-in-part applications or to secure a reissue of such Letters Patent, or to file a disclaimer relating thereto, will upon request, sign all papers, make all rightful oaths and do all lawful acts requisite for the filing of such divisional, continuation, or continuation-in-part application, or such application for reissue and the procuring thereof, and for the filing of such disclaimer, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

And I do further covenant and agree that I will, at any time upon request, communicate to ASSIGNEE, its successors, assigns or other legal representatives, such facts relating to said invention and Letters Patent or the file history thereof as may be known to us, and testify as to the same in any interference or other litigation when requested so to do, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

DATE 1-26-2011

Martin Cenac

103 Melrose Drive Lafayette, LA, 70506

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